

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Series 57 Quick-Release Universal Zero-Insertion-Force DIP Test Socket

FEATURES

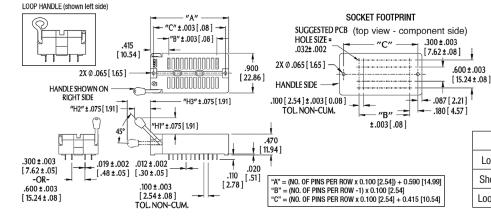
- Accepts Devices on 0.300 to 0.600 [7.62 to 15.24] Centers
- All Pin Count Sockets go into PCB with either 0.300 or 0.600 [7.62 or 15.24] Centers
- Quick-release Handle Swings Down to Open Contacts for Device Insertion; Releasing Handle Automatically Returns to Close onto Device Leads
- · Handle Mounted on either Right- or Left-hand Side
- Solder into PCBs or Plugged into Any Socket

GENERAL SPECIFICATIONS

- STANDARD SOCKET BODY: Black UL 94V-0 Glass-filled Polyphenylene Sulfide (PPS)
- HIGH-TEMP SOCKET BODY: natural color Polyetheretherketone (PEEK)
- HANDLE: Stainless Steel
- HANDLE KNOB: Brass 360, 1/2-hard (no Knob on Loop handle)
- CONTACT MATERIAL: BeCu 172 per QQ-C-553; Spinodal; BeNi 360, 1/2-hard
- ALL BeCu CONTACTS: 50μ [1.27μ] min. Ni under plate per QQ-N-290, over plated with 200μ [5.08μ] min. matte Sn per ASTM B545-97; –0R– 200μ [5.08μ] min. 90/10 Sn/Pb per MIL-T-10727-11 10μ [0.25μ] min. Au per MIL-G-45204
- SPINODAL CONTACT PLATING: 50µ [1.27µ] min. NiB
- HIGH-TEMPERATURE BeNi CONTACT PLATING: 50μ [1.27μ] NiB
- CONTACT CURRENT RATING: 1 amp
- INSULATION RESISTANCE: $1000 \text{ M}\Omega$ min.
- DIELECTRIC WITHSTANDING VOLTAGE: 1000 VAC
- LIFE CYCLE: 25,000 to 50,000 cycles
- OPERATING TEMPERATURE: min. -85°F [-65°C]; max. 221°F [105°C] for Sn plating, 302°F [150°C] for Au plating, 392°F [200°C] for NiB plating, 482°F [250°C] for high-temp socket
- RETENTION FORCE (closed): 55g/pin based on a 0.020 [0.51] dia. test lead
- ACCEPTS LEADS: 0.015-0.035 [0.38-0.89] wide, 0.110-0.280 [2.79-7.11] long

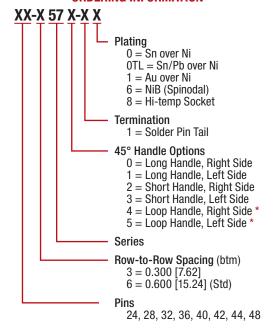
MOUNTING CONSIDERATIONS

See SOCKET FOOTPRINT below



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ORDERING INFORMATION



* Hi-Temp Socket Only

Handle	Dim "H1"	Dim. "H2"	Dim "H3"
Long w/Knob	0.568 [14.43]	0.300 [7.62]	0.471 [11.96]
Short w/ Knob	0.317 [8.05]	0.400 [10.16]	0.252 [6.40]
Loop (no Knob)	0.270 [6.86]	0.193 [4.90]	0.405 [10.29]

ALL DIMENSIONS: INCHES [MILLIMETERS]
ALL TOLERANCES: ±0.005 [0.13] UNLESS OTHERWISE SPECIFIED
FITS TEST SOCKET RECEPTACLE XX-6556-XX, SEE DATA SHEET 10003
CONSULT FACTORY FOR OTHER SIZES AND CONFIGURATIONS

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